LDO Regulator, 100 mA, 18 V, 1 μ A I_Q, with PG

NCV8711

The NCV8711 device is based on unique combination of features – very low quiescent current, fast transient response and high input and output voltage ranges. The NCV8711 is CMOS LDO regulator designed for up to 18 V input voltage and 100 mA output current. Quiescent current of only 1 μ A makes this device ideal solution for battery– powered, always–on systems. Several fixed output voltage versions are available as well as the adjustable version.

The device (version B) implements power good circuit (PG) which indicates that output voltage is in regulation. This signal could be used for power sequencing or as a microcontroller reset.

Internal short circuit and over temperature protections saves the device against overload conditions.

Features

- Operating Input Voltage Range: 2.7 V to 18 V
- Output Voltage: 1.2 V to 17 V
- Capable of Sourcing 140 mA Peak Output Current
- Very Low Quiescent Current: 1 µA typ.
- Low Dropout: 215 mV typ. at 100 mA
- Output Voltage Accuracy ±1%
- Power Good Output (Version B)
- Stable with Small 1 µF Ceramic Capacitors
- Built-in Soft Start Circuit to Suppress Inrush Current
- Over-Current and Thermal Shutdown Protections
- Available in Small TSOP-5 and WDFNW6 (2x2) Packages
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- Body Control Modules
- LED Lighting
- On Board Charger
- General Purpose Automotive



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5 1 1 WDFNW6 (2x2) CASE 483 CASE 511DW

MARKING DIAGRAMS

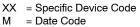


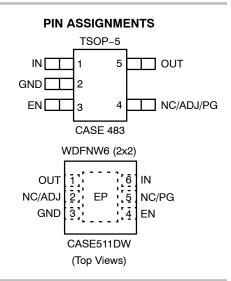
XX = Specific Device Code

- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)







ORDERING INFORMATION

See detailed ordering and shipping information on page 9 of this data sheet.

TYPICAL APPLICATION SCHEMATICS

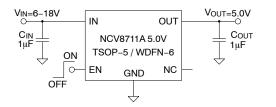
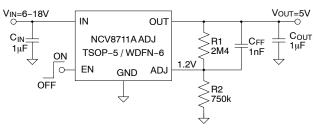


Figure 1. Fixed Output Voltage Application (No PG)





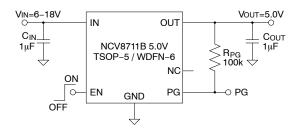


Figure 3. Fixed Output Voltage Application with PG

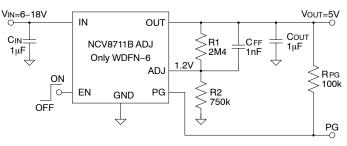
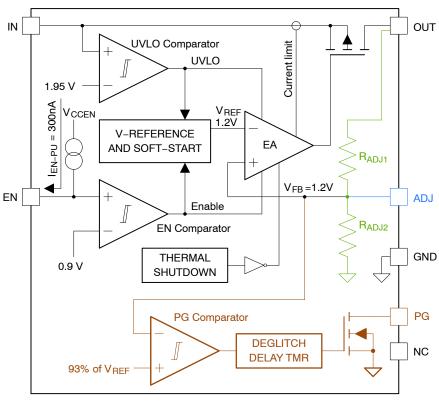


Figure 4. Adjustable Output Voltage Application with PG

$$V_{OUT} = V_{ADJ} \cdot \left(1 + \frac{R_1}{R_2}\right) + I_{ADJ} \cdot R_1$$

SIMPLIFIED BLOCK DIAGRAMS



Note: Blue objects are valid for ADJ version Green objects are valid for FIX version Brown objects are valid for B version (with PG)

Figure 5. Internal Block Diagram

| Pin No. TSOP-5 | Pin No. WDFNW6 | Pin Name | Description |
|----------------|----------------|----------|---|
| 1 | 6 | IN | Power supply input pin. |
| 2 | 3 | GND | Ground pin. |
| 5 | 1 | OUT | LDO output pin. |
| 3 | 4 | EN | Enable input pin (high – enabled, low – disabled). If this pin is connected to IN pin or if it is left unconnected (pull-up resistor is not required) the device is enabled. |
| 4 (Note 1) | 2 | ADJ | Adjust input pin. Connect it to the output resistor divider or directly to the OUT pin. |
| 4 (Note 1) | 5 | PG | Power good output pin. Could be left unconnected or could be connected to GND if not needed. High level for power ok, low level for fail. |
| 4 (Note 1) | 2, 5 | NC | Not internally connected. This pin can be tied to the ground plane to improve thermal dissipation. |
| NA | EP | EPAD | Connect the exposed pad to GND. |

PIN DESCRIPTION

1. Pin function depends on device version.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|---------------------|---|------|
| VIN Voltage (Note 2) | V _{IN} | –0.3 to 22 | V |
| VOUT Voltage | V _{OUT} | –0.3 to [(V _{IN} + 0.3) or 22 V; whichever is lower] | V |
| EN Voltage | V _{EN} | –0.3 to (V _{IN} + 0.3) | V |
| ADJ Voltage | V _{FB/ADJ} | -0.3 to 5.5 | V |
| PG Voltage | V _{PG} | –0.3 to (V _{IN} + 0.3) | V |
| Output Current | I _{OUT} | Internally limited | mA |
| PG Current | I _{PG} | 3 | mA |
| Maximum Junction Temperature | T _{J(MAX)} | 150 | °C |
| Storage Temperature | T _{STG} | –55 to 150 | °C |
| ESD Capability, Human Body Model (Note 3) | ESD _{HBM} | 2000 | V |
| ESD Capability, Charged Device Model (Note 3) | ESD _{CDM} | 1000 | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

 This device series incorporates ESD protection and is tested by the following methods: ESD Human Body Model tested per ANSI/ESDA/JEDEC JS-001, EIA/JESD22-A114 (AEC-Q100-002) ESD Charged Device Model tested per ANSI/ESDA/JEDEC JS-002, EIA/JESD22-C101 (AEC-Q100-011D)

THERMAL CHARACTERISTICS (Note 4)

| Characteristic | Symbol | WDFNW6 2x2 | TSOP-5 | Unit |
|---|--------------------|------------|--------|------|
| Thermal Resistance, Junction-to-Air | R _{thJA} | 63 | 147 | °C/W |
| Thermal Resistance, Junction-to-Case (top) | R _{thJCt} | 204 | 82 | °C/W |
| Thermal Resistance, Junction-to-Case (bottom) | R _{thJCb} | 15 | N/A | °C/W |
| Thermal Resistance, Junction-to-Board (top) | R _{thJBt} | 47 | 113 | °C/W |
| Thermal Characterization Parameter, Junction-to-Case (top) | Psi _{JCt} | 4 | 22 | °C/W |
| Thermal Characterization Parameter, Junction-to-Board [FEM] | Psi _{JB} | 46 | 113 | °C/W |

Measured according to JEDEC board specification (board 1S2P, Cu layer thickness 1 oz, Cu area 650 mm², no airflow). Detailed description
of the board can be found in JESD51–7.

ELECTRICAL CHARACTERISTICS (V_{IN} = V_{OUT-NOM} + 1 V and V_{IN} \ge 2.7 V, V_{EN} = 1.2 V, I_{OUT} = 1 mA, C_{IN} = C_{OUT} = 1.0 μ F (effective capacitance – Note 5), T_J = -40°C to 125°C, ADJ tied to OUT, unless otherwise specified) (Note 6)

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|-------------------------------|---|---------------------------|------|------|-----|-------------------|
| Recommended Input Voltage | | V _{IN} | 2.7 | - | 18 | V |
| Output Voltage Accuracy | $T_J = -40^{\circ}C \text{ to } +85^{\circ}C$ | V _{OUT} | -1 | - | 1 | % |
| | $T_J = -40^{\circ}C$ to $+125^{\circ}C$ | | -1 | - | 2 | |
| ADJ Reference Voltage | ADJ version only | V _{ADJ} | - | 1.2 | - | V |
| ADJ Input Current | V _{ADJ} = 1.2 V | I _{ADJ} | -0.1 | 0.01 | 0.1 | μA |
| Line Regulation | V_{IN} = $V_{\text{OUT-NOM}}$ + 1 V to 18 V and V_{IN} \geq 2.7 V | $\Delta V_{O(\Delta VI)}$ | - | - | 0.2 | %V _{OUT} |
| Load Regulation | I _{OUT} = 0.1 mA to 100 mA | $\Delta V_{O(\Delta IO)}$ | - | - | 0.4 | %V _{OUT} |
| Quiescent Current (version A) | $V_{IN} = V_{OUT-NOM} + 1 V$ to 18 V, $I_{OUT} = 0 mA$ | ۱ _Q | - | 1.3 | 2.5 | μA |
| Quiescent Current (version B) | $V_{IN} = V_{OUT-NOM} + 1 V$ to 18 V, $I_{OUT} = 0 mA$ | | _ | 1.8 | 3.0 | |
| Ground Current | I _{OUT} = 100 mA | I _{GND} | - | 325 | 450 | μA |
| Shutdown Current (Note 10) | V _{EN} = 0 V, I _{OUT} = 0 mA, V _{IN} = 18 V | I _{SHDN} | - | 0.35 | 1.5 | μA |
| Output Current Limit | V _{OUT} = V _{OUT-NOM} – 100 mV | I _{OLIM} | 140 | 250 | 450 | mA |
| Short Circuit Current | V _{OUT} = 0 V | I _{OSC} | 140 | 250 | 450 | mA |
| Dropout Voltage (Note 7) | I _{OUT} = 100 mA | V _{DO} | - | 215 | 355 | mV |

| Parameter | Test Conditions | | Symbol | Min | Тур | Max | Unit |
|--------------------------------------|---|------------------------|---------------------|------|------|------|-------------------|
| Power Supply Ripple Rejection | $V_{IN} = V_{OUT-NOM} + 2 V$ | 10 Hz | PSRR | - | 80 – | dB | |
| | l _{OUT} = 10 mA | 10 kHz | | - | 70 | - | |
| | | 100 kHz | | - | 42 | - | |
| | | 1 MHz | | - | 48 | - | |
| Output Noise | f = 10 Hz to 100 kHz, V_{OUT-} | _{NOM} = 5.0 V | V _N | - | 240 | - | μV _{RMS} |
| EN Threshold | V _{EN} rising | | V _{EN-TH} | 0.7 | 0.9 | 1.05 | V |
| EN Hysteresis | V _{EN} falling | | V _{EN-HY} | 0.01 | 0.1 | 0.2 | V |
| EN Internal Pull-up Current | V _{EN} = 1 V, V _{IN} = 5.5 V | | I _{EN-PU} | 0.01 | 0.3 | 1 | μA |
| EN Input Leakage Current | V _{EN} = 18 V, V _{IN} = 18 V | | I _{EN-LK} | -1 | 0.05 | 1 | μA |
| Start-up time (Note 8) | $V_{OUT-NOM} \le 3.3 V$ | | t _{START} | 100 | 250 | 500 | μs |
| | V _{OUT-NOM} > 3.3 V | | 300 60 | 600 | 1000 | | |
| Internal UVLO Threshold | Ramp V _{IN} up until output is turned on | | V _{IUL-TH} | 1.6 | 1.95 | 2.6 | V |
| Internal UVLO Hysteresis | Ramp V_{IN} down until output | is turned off | V _{IUL-HY} | 0.05 | 0.2 | 0.3 | V |
| PG Threshold (Note 9) | V _{OUT} falling | | V _{PG-TH} | 90 | 93 | 96 | % |
| PG Hysteresis (Note 9) | V _{OUT} rising | | V _{PG-HY} | 0.1 | 2 | 3.5 | % |
| PG Deglitch Time (Note 9) | | | t _{PG-DG} | 75 | 160 | 270 | μs |
| PG Delay Time (Note 9) | | | t _{PG-DLY} | 120 | 320 | 600 | μs |
| PG Output Low Level Voltage (Note 9) | I _{PG} = 1 mA | | V _{PG-OL} | - | 0.2 | 0.4 | V |
| PG Output Leakage Current (Note 9) | V _{PG} = 18 V | | I _{PG-LK} | - | 0.01 | 1 | μA |
| Thermal Shutdown Temperature | Temperature rising from $T_J = +25^{\circ}C$ | | T _{SD} | - | 165 | - | °C |
| Thermal Shutdown Hysteresis | Temperature falling from T _{SD} | | T _{SDH} | - | 20 | - | °C |

| ELECTRICAL CHARACTERISTICS (V _{IN} = V _{OUT-NOM} + 1 V and V _{IN} \ge 2.7 V, V _{EN} = 1.2 V, I _{OUT} = 1 mA, C _{IN} = C _{OUT} = 1.0 μ F | |
|---|--|
| (effective capacitance – Note 5), T _J = -40°C to 125°C, ADJ tied to OUT, unless otherwise specified) (Note 6) (continued) | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Effective capacitance, including the effect of DC bias, tolerance and temperature. See the Application Information section for more information.

 Performance guaranteed over the indicated operating temperature range by design and/or characterization. Production tested at T_A = 25°C. Low duty cycle pulse techniques are used during the testing to maintain the junction temperature as close to ambient as possible.

7. Dropout measured when the output voltage falls 100 mV below the nominal output voltage. Limits are valid for all voltage versions.

8. Startup time is the time from EN assertion to point when output voltage is equal to 95% of V_{OUT-NOM}.

9. Applicable only to version B (device option with power good output). PG threshold and PG hysteresis are expressed in percentage of nominal output voltage.

10. Shutdown current includes EN Internal Pull-up Current.

TYPICAL CHARACTERISTICS

 $V_{IN} = V_{OUT-NOM} + 1 V \text{ and } V_{IN} \ge 2.7 V, V_{EN} = 1.2 V, I_{OUT} = 1 \text{ mA}, C_{OUT} = 1.0 \mu\text{F}, \text{ADJ tied to OUT}, T_J = 25^{\circ}\text{C}, \text{ unless otherwise specified}$

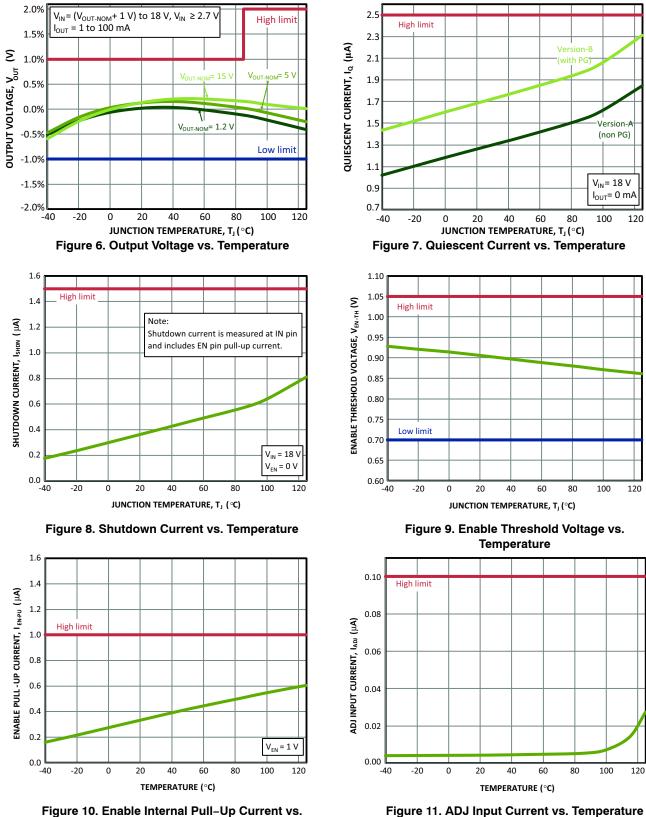


Figure 10. Enable Internal Pull-Up Current vs. Temperature

TYPICAL CHARACTERISTICS

 $V_{IN} = V_{OUT-NOM} + 1 \text{ V and } V_{IN} \geq 2.7 \text{ V}, V_{EN} = 1.2 \text{ V}, I_{OUT} = 1 \text{ mA}, C_{OUT} = 1.0 \text{ } \mu\text{F}, \text{ ADJ tied to OUT}, T_J = 25^{\circ}\text{C}, \text{ unless otherwise specified}$

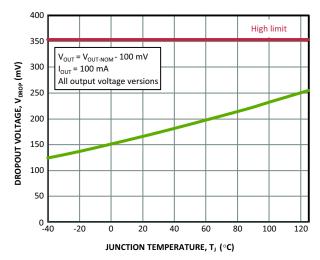


Figure 12. Dropout Voltage vs. Temperature

TYPICAL CHARACTERISTICS

 $V_{IN} = V_{OUT-NOM} + 1 V \text{ and } V_{IN} \ge 2.7 V, V_{EN} = 1.2 V, I_{OUT} = 1 \text{ mA}, C_{OUT} = 1.0 \mu\text{F}, \text{ADJ tied to OUT}, T_J = 25^{\circ}\text{C}, \text{ unless otherwise specified}$

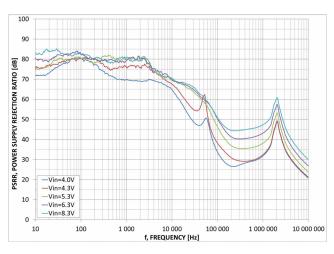


Figure 13. PSRR – FIX–3.3 V, C_{OUT} = 1 μ F, I_{OUT} = 100 mA

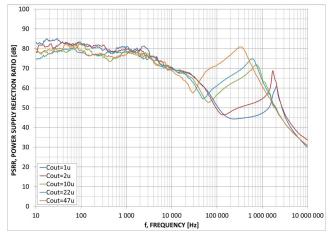


Figure 15. PSRR – FIX–3.3 V, V_{IN} = 8.3 V, I_{OUT} = 100 mA

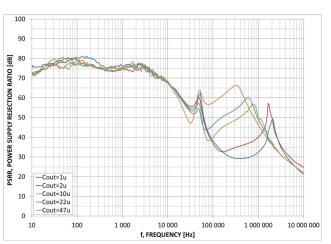


Figure 14. PSRR – FIX–3.3 V, V_{IN} = 4.3 V, I_{OUT} = 100 mA

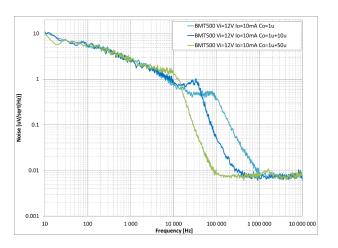
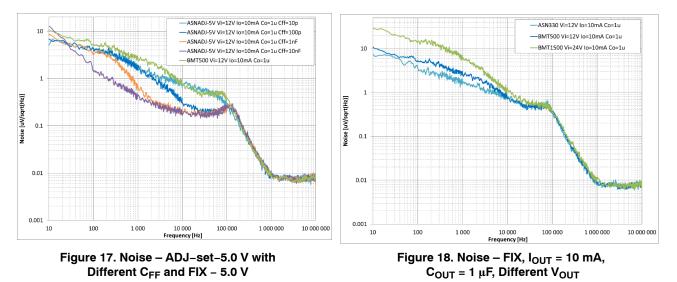


Figure 16. Noise – FIX – 5.0 V, I_{OUT} = 10 mA, Different C_{OUT}



ORDERING INFORMATION

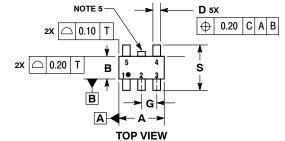
| Part Number | Marking | Voltage Option (V _{OUT-NOM}) | Version | Package | Shipping | |
|-------------------|---------|--|-----------------------|---------------------|--------------------|--|
| NCV8711ASNADJT1G | GGA | ADJ | | | | |
| NCV8711ASN300T1G | GGC | 3.0 V | Without PG With PG | TSOP-5 (Pb-Free) | 3000 / Tape & Reel | |
| NCV8711ASN330T1G | GGD | 3.3 V | | | | |
| NCV8711ASN500T1G | GGE | 5.0 V | | | | |
| NCV8711BMTWADJTBG | GA | ADJ | | WDFNW6 (Pb-Free) | 0000 (Total 0 Date | |
| NCV8711BMTW300TBG | GC | 3.0 V | | | | |
| NCV8711BMTW330TBG | GD | 3.3 V | | | 3000 / Tape & Reel | |
| NCV8711BMTW500TBG | GE | 5.0 V | 1 | | | |

NOTE: To order other package, voltage version or PG / non PG variant, please contact your ON Semiconductor sales representative.

PACKAGE DIMENSIONS

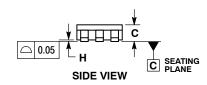
TSOP-5 CASE 483 ISSUE M

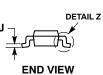
 NOTES:
 DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS. SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A.
 OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION.



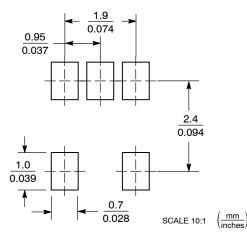


DETA





SOLDERING FOOTPRINT*

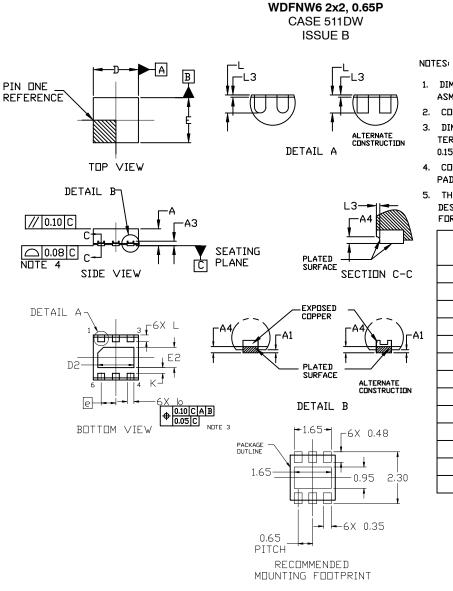


*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY. MILLIMETERS DIM MIN MAX

| | MILLIMETERS | | | | |
|-----|-------------|----------|--|--|--|
| DIM | MIN | MAX | | | |
| Α | 2.85 | 3.15 | | | |
| в | 1.35 | 1.65 | | | |
| С | 0.90 | 1.10 | | | |
| D | 0.25 0.50 | | | | |
| G | 0.95 | 0.95 BSC | | | |
| Н | 0.01 | 0.10 | | | |
| J | 0.10 | 0.26 | | | |
| К | 0.20 | 0.60 | | | |
| м | 0 ° | 0° 10° | | | |
| S | 2.50 3.00 | | | | |

PACKAGE DIMENSIONS



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION & APPLIES TO PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
- THIS DEVICE CONTAINS WETTABLE FLANK DESIGN FEATURES TO AID IN FILLET FORMATION ON THE LEADS DURING MOUNTING.

| | MILLIMETERS | | | | |
|-----|-------------|----------|------|--|--|
| DIM | MIN. | NDM. | MAX. | | |
| Α | 0.70 | 0.75 | 0.80 | | |
| A1 | 0. | | 0.05 | | |
| A3 | l | 0.20 REF | - | | |
| A4 | 0.10 | | | | |
| b | 0.25 | 0.30 | 0.35 | | |
| D | 1.90 | 2.00 | 2.10 | | |
| D2 | 1.50 | 1.60 | 1.70 | | |
| Е | 1.90 | 2.00 | 2.10 | | |
| E2 | 0.80 | 0.90 | 1.00 | | |
| e | 0.65 BSC | | | | |
| к | 0.25 REF | | | | |
| L | 0.25 | 0.30 | 0.35 | | |
| L3 | 0.05 REF | | | | |

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